

**Rectifier Diodes**

**FEATURES**

- ◆ For surface mounted applications
- ◆ Glass Passivated Chip Junction
- ◆ Fast reverse recovery time
- ◆ Ideal for automated placement
- ◆ Lead free in comply with EU RoHS 2011/65/EU directives

**MECHANICAL DATA**

- ◆ Case: SOD-323
- ◆ Terminals: Solderable per MIL-STD-750, Method 2026
- ◆ Approx. Weight: 5.48mg /0.00019oz

**Absolute Maximum Ratings at 25 °C**

Parameter	Symbols	1N4007WS	Units
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	140	V
Maximum RMS voltage	$V_{RMS}$	100	V
Continuous Forward Current	$I_{F(AV)}$	250	mA
Non-reptitive Peak Forward Surge Current	$I_{FSM}$	at 1s	0.5
		at 1ms	1
		at 1us	4
Total Power Dissipation	$P_{tot}$	500	mW
Typical Thermal Resistance (1)	$R_{\theta JA}$	340	°C/W
	$R_{\theta JC}$	120	
Operating and Storage Temperature Range	$T_j, T_{stg}$	-55 ~ +150	°C

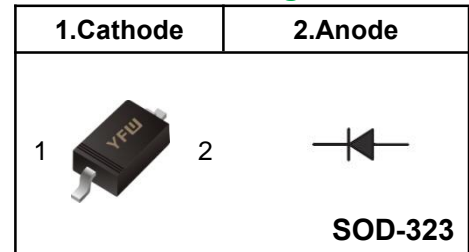
(1) P.C.B. mounted with 5\*5mm copper pad areas.

**Characteristics at Ta = 25 °C**

Parameter	Symbols	1N4007WS	Units
Reverse Breakdown Voltage at $I_R=1\mu A$	$V_{(BR)R}$	100	V
Maximum Forward Voltage	$V_F$	at 1 mA	0.715
		at 10 mA	0.855
		at 50 mA	1.00
		at 150 mA	1.25
Peak Reverse Current	$I_R$	at $V_R=20V, T_j=25^\circ C$	0.025
		at $V_R=100V, T_j=25^\circ C$	1
		at $V_R=25V, T_j=150^\circ C$	30
		at $V_R=100V, T_j=150^\circ C$	50
Typical Junction Capacitance $f=1MHz, V_R=0V$	$C_j$	2	pF
Maximum Reverse Recovery Time (2)	$T_{rr}$	4	nS

(2) Measured with  $I_F=I_R=10mA, I_{rr}=0.1xI_R, R_L=100\Omega$

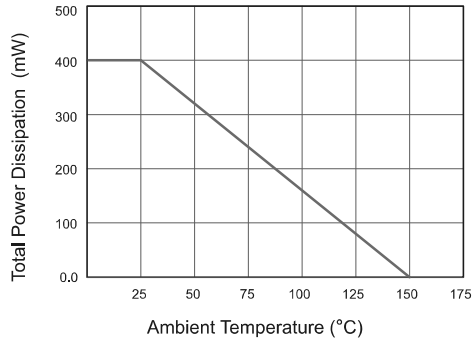
**Pinning**



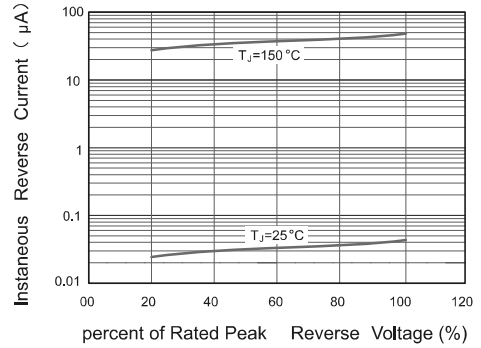
**Marking Code**

1N4007WS	T7
----------	----

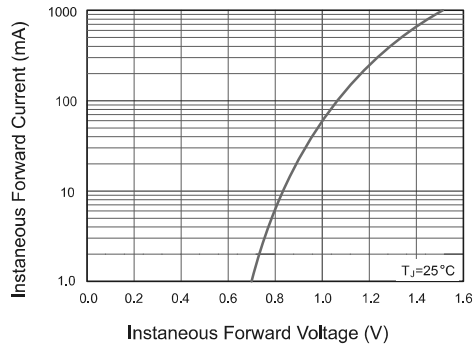
**Fig.1 Power Derating Curve**



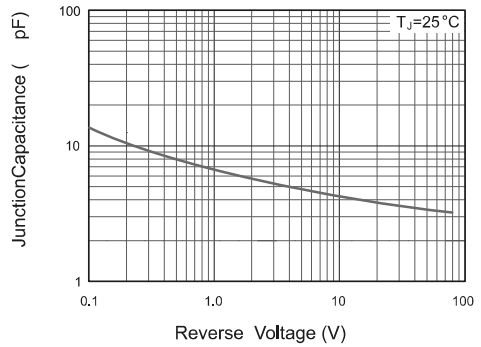
**Fig.2 Typical Reverse Characteristics**



**Fig.3 Typical Instaneous Forward Characteristics**



**Fig.4 Typical Junction Capacitance**



**Ordering information**

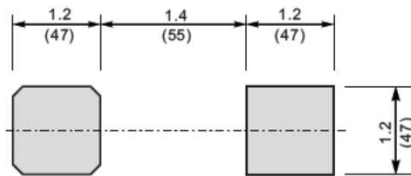
Package	Packing Description	Packing Quantity
SOD-323	Tape/Reel, 7" reel	3000PCS/Reel 120000PCS/Carton

**Package Dimensions**

**SOD-323**

Dim.	Millimeter(mm)		mil	
	Min.	Max.	Min.	Max.
A	0.8	1.1	32	43
C	0.08	0.15	3.1	5.9
D	1.2	1.4	47	55
E	1.4	1.8	63	70
E1	2.55	2.75	100	108
b	0.25	0.4	9.8	16
L1	0.2	0.45	7.9	16
A1	-	0.2	-	8
∠	9°			

**The recommended mounting pad size**



Unit:  $\frac{\text{mm}}{\text{mil}}$

## Disclaimer

The information presented in this document is for reference only. GuangDong Youfeng Microelectronics Co.,Ltd. reserves the right to make changes without notice for the specification of the products displayed herein to improve reliability, function or design or otherwise. The product listed herein is designed to be used with ordinary electronic equipment or devices, and not designed to be used with equipment or devices which require high level of reliability and the malfunction of with would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices),YFW or anyone on its behalf, assumes no responsibility or liability for any damages resulting from such improper use of sale. This publication supersedes & replaces all information previously supplied. For additional information, please visit our website <https://www.yfwdiode.com>, or consult YFW sales office for further assistance.